#### The Wideband IC Line

# RF LDMOS Wideband Integrated Power Amplifiers

The MW4IC2230 wideband integrated circuit is designed for W-CDMA base station applications. It uses Motorola's newest High Voltage (26 to 28 Volts) LDMOS IC technology and integrates a multi-stage structure. Its wideband On-Chip design makes it usable from 1600 to 2400 MHz. The linearity performances cover all modulations for cellular applications: GSM, GSM EDGE, TDMA, CDMA and W-CDMA.

**Final Application** 

Typical Single-carrier W-CDMA Performance:  $V_{DD}=28$  Volts,  $I_{DQ1}=60$  mA,  $I_{DQ2}=350$  mA,  $P_{out}=5$  Watts Avg., f=2140 MHz, Channel Bandwidth = 3.84 MHz, Peak/Avg. = 8.5 dB @ 0.01% Probability on CCDF.

Power Gain — 31 dB Drain Efficiency — 15% ACPR @ 5 MHz = -45 dBc @ 3.84 MHz Bandwidth

**Driver Application** 

Typical Single-carrier W-CDMA Performance:  $V_{DD}=28$  Volts,  $I_{DQ1}=60$  mA,  $I_{DQ2}=350$  mA,  $P_{out}=0.4$  Watts Avg., f=2140 MHz, Channel Bandwidth = 3.84 MHz, Peak/Avg. = 8.5 dB @ 0.01% Probability on CCDF. Power Gain — 31.5 dB

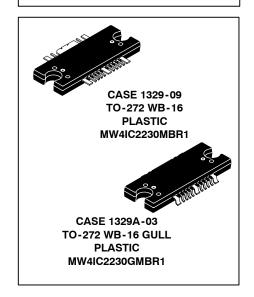
ACPR @ 5 MHz = -53.5 dBc @ 3.84 MHz Bandwidth

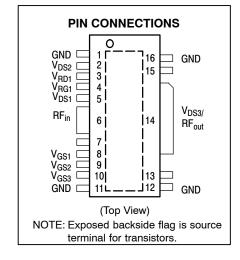
- Capable of Handling 3:1 VSWR, @ 28 Vdc, 2170 MHz, 5 Watts CW Output Power
- Characterized with Series Equivalent Large-Signal Impedance Parameters
- On-Chip Matching (50 Ohm Input, DC Blocked, >5 Ohm Output)
- Integrated Temperature Compensation with Enable/Disable Function
- On-Chip Current Mirror g<sub>m</sub> Reference FET for Self Biasing Application (1)
- Integrated ESD Protection
- · Also Available in Gull Wing for Surface Mount
- In Tape and Reel. R1 Suffix = 500 Units per 44 mm, 13 inch Reel

# V<sub>RG1</sub> V<sub>DS2</sub> V<sub>DS1</sub> RF<sub>in</sub> V<sub>DS3</sub>/RF<sub>out</sub> V<sub>GS2</sub> V<sub>GS2</sub> V<sub>GS3</sub> V<sub>GS3</sub> V<sub>GS2</sub> V<sub>GS3</sub> Functional Block Diagram

# MW4IC2230MBR1 MW4IC2230GMBR1

2110-2170 MHz, 30 W, 28 V SINGLE W-CDMA RF LDMOS WIDEBAND INTEGRATED POWER AMPLIFIERS





(1) Refer to AN1987/D, Quiescent Current Control for the RF Integrated Circuit Device Family. Go to <a href="http://www.motorola.com/semiconductors/rf">http://www.motorola.com/semiconductors/rf</a>. Select Documentation/Application Notes - AN1987.

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#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Drain-Source Voltage	$V_{DSS}$	65	Vdc
Gate - Source Voltage	$V_{GS}$	-0.5, +8	Vdc
Storage Temperature Range	T <sub>stg</sub>	-65 to +175	°C
Operating Channel Temperature	TJ	175	°C
Input Power	P <sub>in</sub>	20	dBm

#### THERMAL CHARACTERISTICS

Characteristic		Value (1)	Unit
Thermal Resistance, Junction to Case	$R_{ heta JC}$		°C/W
Stage 1		10.5	
Stage 2		5.1	
Stage 3		2.3	

#### **ESD PROTECTION CHARACTERISTICS**

Test Conditions	Class
Human Body Model	2 (Minimum)
Machine Model	M3 (Minimum)
Charge Device Model	C5 (Minimum)

#### **MOISTURE SENSITIVITY LEVEL**

Test Methodology	Rating
Per JESD 22-A113	3

#### **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
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FUNCTIONAL TESTS (In Motorola Test Fixture, 50 ohm system)  $V_{DD} = 28$  Vdc,  $I_{DQ1} = 60$  mA,  $I_{DQ2} = 350$  mA,  $I_{DQ3} = 265$  mA, Pout = 0.4 W Avg., f = 2110 MHz, f = 2170 MHz, Single-carrier W-CDMA. ACPR measured in 3.84 MHz Channel Bandwidth @ ±5 MHz Offset. Peak/Avg. Ratio = 8.5 dB @ 0.01% Probability on CCDF.

Power Gain	G <sub>ps</sub>	29	31.5	_	dB
Input Return Loss	IRL	_	-25	-10	dB
Adjacent Channel Power Ratio $\begin{aligned} P_{out} &= 0.4 \text{ W Avg.} \\ P_{out} &= 1.26 \text{ W Avg.} \end{aligned}$	ACPR	_ _	-53.5 -52	-50 —	dBc
Stability (10 mW <p<sub>out&lt;5 W CW, Load VSWR = 3:1, All Phase Angles, 24 V<vds<28 td="" v)<=""><td></td><td colspan="3">No Spurious &gt; -60 dBc</td><td></td></vds<28></p<sub>		No Spurious > -60 dBc			

TYPICAL PERFORMANCES (In Motorola Test Fixture tuned for 0.4 W Avg. W-CDMA driver) VDD = 28 Vdc, IDQ1 = 60 mA, IDQ2 = 350 mA, I<sub>DQ3</sub> = 265 mA, 2110 MHz<Frequency <2170 MHz

Saturated Pulsed Output Power (f = 1 kHz, Duty Cycle 10%)	P <sub>sat</sub>	_	43	_	Watts
Quiescent Current Accuracy over Temperature (-10 to 85°C)	$\Delta I_{QT}$	_	±5	_	%
Gain Flatness in 30 MHz Bandwidth	G <sub>F</sub>	_	0.13	_	dB
Deviation from Linear Phase in 30 MHz Bandwidth	Φ	_	±1	_	0
Delay @ P <sub>out</sub> = 0.4 W CW Including Output Matching	Delay	_	1.6	_	ns
Part to Part Phase Variation	ΦΔ	_	±15	=	0

<sup>(1)</sup> MTTF calculator available at http://www.motorola.com/semiconductors/rf. Select Tools/Software/Application Software/Calculators to access the MTTF calculators by product.

(continued)

**ELECTRICAL CHARACTERISTICS** — **continued** (T<sub>C</sub> = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit

**TYPICAL PERFORMANCES** (In Motorola Reference Application Circuit tuned for 2-carrier W-CDMA signal)  $V_{DD}$  = 28 Vdc,  $P_{out}$  = 0.4 W Avg.,  $I_{DQ1}$  = 60 mA,  $I_{DQ2}$  = 400 mA,  $I_{DQ3}$  = 245 mA, f1 = 2112.5 MHz, f2 = 2122.5 MHz and f1 = 2157.5 MHz, f2 = 2167.5 MHz, 2-carrier W-CDMA, 3.84 MHz Channel Bandwidth Carriers. ACPR measured in 3.84 MHz Channel Bandwidth @ ±5 MHz Offset. IM3 measured in 3.84 MHz Channel Bandwidth @ ±10 MHz Offset. Peak/Avg. = 8.5 dB @ 0.01% Probability on CCDF.

Power Gain	G <sub>ps</sub>	_	31.5	_	dB
Intermodulation Distortion	IM3	_	-52	_	dBc
Adjacent Channel Power Ratio	ACPR	_	-55	_	dBc
Input Return Loss	IRL	_	-26	_	dB

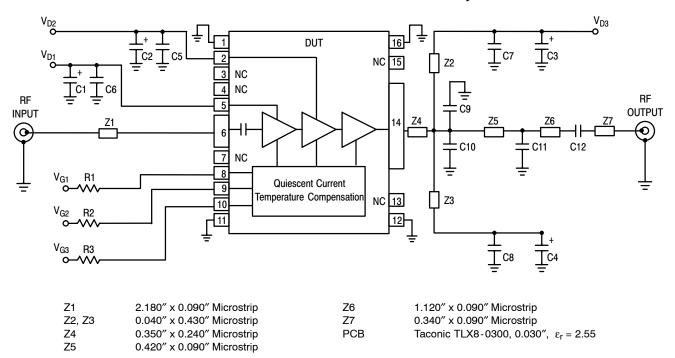


Figure 1. MW4IC2230MBR1(GMBR1) Test Circuit Schematic

Table 1. MW4IC2230MBR1(GMBR1) Test Circuit Component Designations and Values

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Part	Description	Part Number	Manufacturer
C1, C2, C3, C4	10 μF, 35 V Tantalum Capacitors	TAJD106K035	AVX
C5, C6, C7, C8, C12	8.2 pF 100B Chip Capacitors	100B8R2CW	ATC
C9, C10	1.8 pF 100B Chip Capacitors	100B1R8BW	ATC
C11	0.3 pF 100B Chip Capacitor	100B0R3BW	ATC
R1, R2, R3	1.8 kΩ Chip Resistors (1206)		

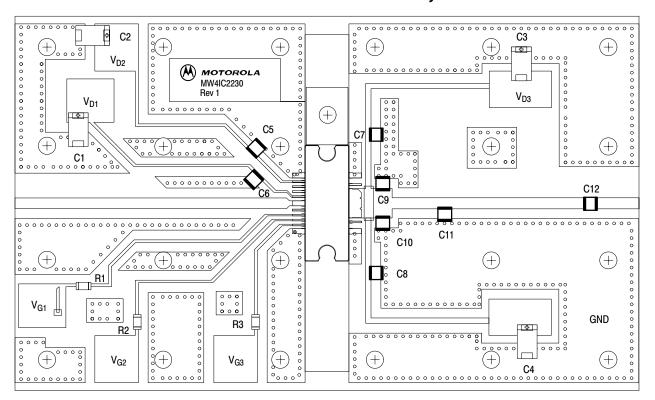


Figure 2. MW4IC2230MBR1(GMBR1) Test Circuit Component Layout

#### **TYPICAL CHARACTERISTICS**

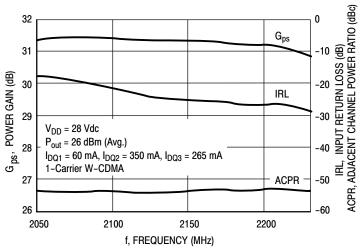


Figure 3. Single-Carrier W-CDMA Wideband Performance

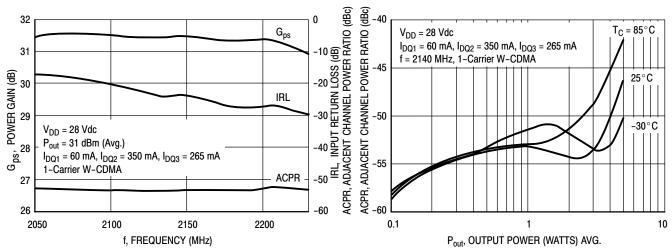


Figure 4. Single-Carrier W-CDMA Wideband Performance

Figure 5. Adjacent Channel Power Ratio versus Output Power

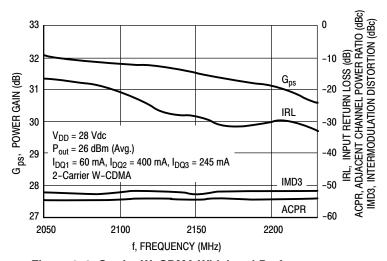
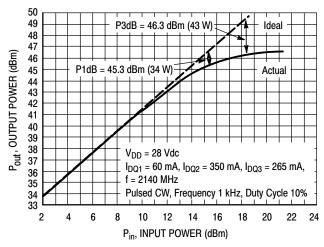


Figure 6. 2-Carrier W-CDMA Wideband Performance

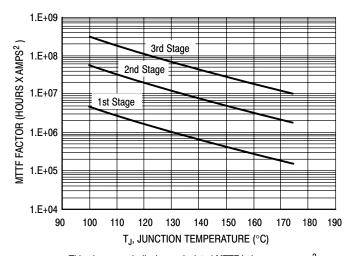
#### **TYPICAL CHARACTERISTICS**



2.00 V<sub>DD</sub> = 28 Vdc, Small Signal 1.95  $I_{DQ1}$  = 60 mA,  $I_{DQ2}$  = 350 mA,  $I_{DQ3}$  = 265 mA 1.90 1.85 DELAY (ns) 1.80 1.75 1.70 1.65 1.60 1.55 1.50 1950 2000 2050 2100 2150 2200 2250 2300 f, FREQUENCY (MHz)

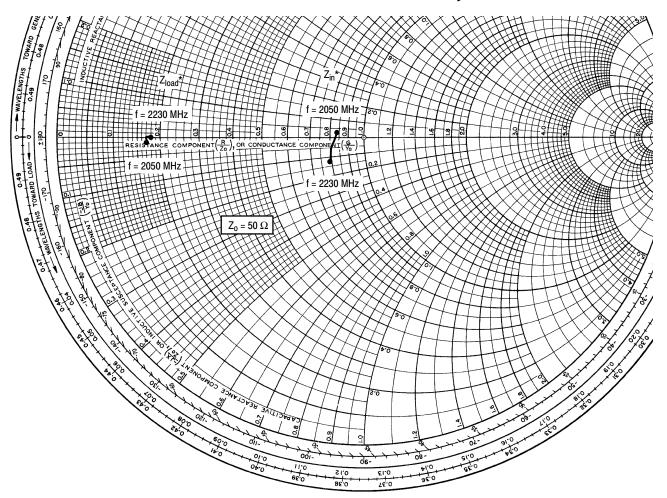
Figure 7. Output Power versus Input Power

Figure 8. Delay versus Frequency



This above graph displays calculated MTTF in hours x ampere<sup>2</sup> drain current. Life tests at elevated temperatures have correlated to better than  $\pm 10\%$  of the theoretical prediction for metal failure. Divide MTTF factor by ID2 for MTTF in a particular application.

Figure 9. MTTF Factor versus Temperature Junction



 $V_{DD} = 28 \; V, \, I_{DQ1} = 60 \; mA, \, I_{DQ2} = 350 \; mA, \, I_{DQ3} = 265 \; mA, \, P_{out} = 26 \; dBm$ 

DD - 7 DQ1 7 DQ2 7 DQ0 7 Out					
f MHz	$oldsymbol{z_{in}}{\Omega}$	$oldsymbol{Z_{load}}{\Omega}$			
2050	42.18 + j1.49	8.52 - j0.46			
2110	41.06 - j1.30	8.58 - j0.20			
2140	40.49 - j2.42	8.63 - j0.09			
2170	40.05 - j3.45	8.69 - j0.01			
2230	39.29 - j6.31	8.81 + j0.04			

 $Z_{in}$  = Device input impedance as measured from gate to ground.

Z<sub>load</sub> = Test circuit impedance as measured from drain to ground.

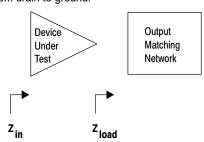
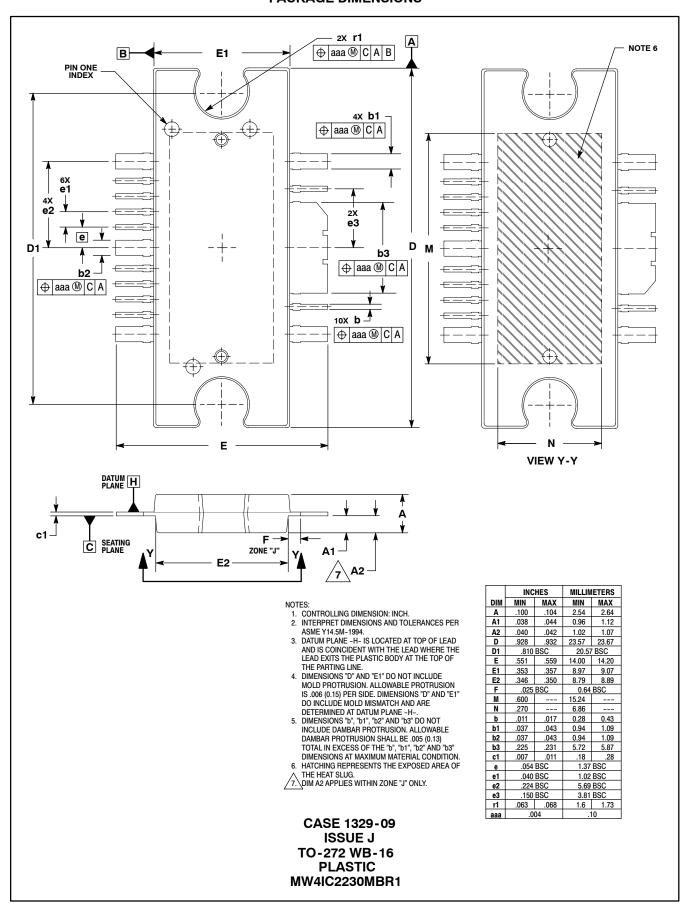
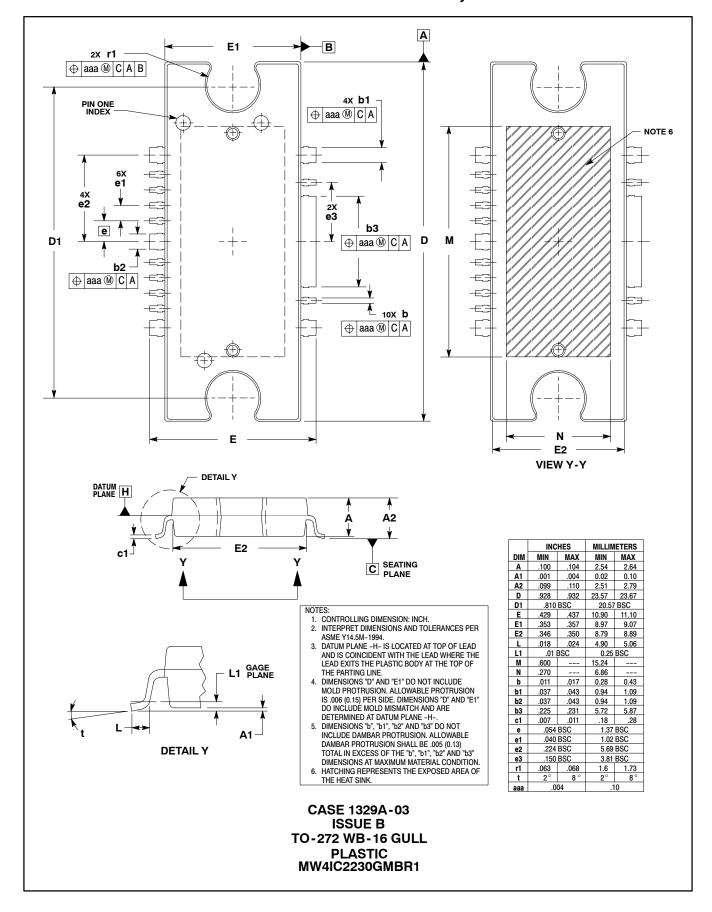


Figure 10. Series Equivalent Input and Load Impedance

#### **PACKAGE DIMENSIONS**





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